**ORDER DESCRIPTION**

1. **Object of the contract**

The subject of the order is the supply of semiconductors wafers listed below by name and quantity needed:

1. InP SI 6” DSP 20 pieces

1. **The scope of the subject of the contract**

A detailed description of the subject of the contract is provided in section 5 of this document.

1. **Criterion**

Offers will be evaluated according to a point scale with a maximum number of points of 100.

|  |  |  |
| --- | --- | --- |
| Criterion | Maximum number of points S | Method of awarding points |
| Net Price (P) | 100 | S x Pmin/Pi |

Where:

* Pi – price of goods - for the given offer
* Pmin - the minimum delivery price for the ordered goods from all offers submitted
* S – number of points

The final score will be calculated by adding up the partial components and then rounded to two decimal places. (rounded from "5" up)

1. **Deadline for completing the order**

Up to 5 weeks from the date of placing the order. The Ordering Party requires the application of the EXW Incoterms 2020 delivery principle. EXW (ex works), i.e. the moment of delivery of the goods is considered to be at the disposal of the buyer in the area indicated by the supplier (factory, plant, etc.).

1. **Parameters**

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| --- | --- | --- | --- |
| Product name | | Parametrer | Specification |
| **InP Semi Insulating**  **Doped with Fe** | Diameter 6”  Thickness: 650±50 µm  Diameter: 150±0.5 mm | Grade: | Mechanical, Epi-ready |
| Orientation: | (100) 2° off toward <110>±0.5° |
| Primary Flat: | Notched [010] ±2o |
| Resistivity: | >5E6 ohm cm |
| Surface Finish: | DSP (double side polished)  Side 1: Polished  Side 2: Polished |
| Laser Mark | On front |
| Packaging: | individual box, sealed with N2 in a moisture-stopping metallic foil bag, done in class 100 clean room. |